



Product Change Notification

Change Notification #: 118621-00
Change Title: Select Intel® RAID Adapters and Intel® Storage Adapters, PCN 118621-00, Documentation, Top Assembly Value Change
Date of Publication: October 25, 2021

Key Characteristics of the Change:

Documentation

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*	November 09, 2021
Date of First Availability of Post-Conversion Material*	November 08, 2021

* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

The Intel SKUs listed in the products affected table will have a Top Assembly (TA) number change, however nothing is changing in the product. This is an internal documentation change required at Intel.

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Please contact your local Intel Field Sales Rep if you have any further questions about these changes in TA number.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Post Change TA
Intel® Storage Adapter RSP3QD160J	RSP3QD160J	954491	J40727-004	J40727-005
Intel® Storage Adapter RSP3GD016J	RSP3GD016J	954492	J40737-004	J40737-005
Intel® RAID Adapter RSP3TD160F	RSP3TD160F	954493	J40741-005	J40741-006
Intel® RAID Adapter RSP3WD080E	RSP3WD080E	954495	J55265-005	J55265-006
Intel® RAID Adapter RSP3DD080F	RSP3DD080F	954496	J40745-005	J40745-006
Intel® RAID Adapter RSP3MD088F	RSP3MD088F	954551	J40747-005	J40747-006

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
October 25, 2021	00	Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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